Form **PTO-1595** .S. DEPARTMENT OF COMMERCE RECOR (Rev. 10/02) U.S. Patent and Trademark Office OMB No. 0651-0027 (exp. 6/30/2005) 102735588 TSM03-0376 To the honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. 2. Name and address of receiving party(ies) Name of conveying party(ies): Name: Taiwan Semiconductor Manufacturing Company, Chih-Hao Wang Yu-Shen Lai Internal Address: Additional name(s) of conveying party(ies) attached? Yes X No တ် 3. Nature of conveyance: | X | Assignment Merger Street Address: No. 6, Li-Hsin Rd. 6 Security Agreement Change of Name Science-Based Industrial Park City: Hsin-Chu State: Taiwan Zip: 300-77 Execution Date: April 26, 2004 Additional name(s) & address(es) attached? Yes X No 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: April 26, 2004 Patent Application No.(s) B. Patent No.(s) Additional numbers attached? Yes No 5. Name and address of party to whom correspondence concerning document should be mailed: 6. Total number of applications and patents 1 involved: Name: Steven H. Slater 7. Total fee (37 CFR 3.41). \$ _____ 40.00 Slater & Matsil, L.L.P. Enclosed Internal Address: X Authorized to be charged to deposit account Street Address:17950 Preston Rd. 8. Deposit account number: Suite 1000 50-1065 City: Dallas State: Texas Zip: 75252-5793 (Attach duplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true, and correct and any attached copy Is a true copy of the original document. April 27, 2004 Roger C. Knapp, Reg. No. 46,836 Signatus Name of Person Signing Date Total number of pages including cover sheet, attachments, and documents: 2 Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments 30/2004 ECDOPER 00000068 501065 10832679

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ATTORNEY DOCKET NO. TSM03-0376

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ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. (TSMC), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 6, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C., is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TSMC, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TSMC, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to TSMC, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TSMC, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TSMC, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	Dual Work-Function Metal Gates		
SIGNATURE OF INVENTOR AND NAME	Chih-Hao Wang Chih-Hao Wang	Yu-Shen Lat,	
DATE	26-Apr-2004	26-Apr. 2006	
RESIDENCE (City, County, State)	Hsin-Chu, Taiwan R.O.C.	Hsin-Chu, Taiwan, R.O.C.	

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RECORDED: 04/27/2004